### INTEGRATED CIRCUITS

# DATA SHEET

# 74F621

Octal bus transceiver, non-inverting (open collector)

Product specification

1996 Jan 05

IC15 Data Handbook





### Octal bus transceiver, non-inverting (open collector)

74F621

### **FEATURES**

- High-impedance NPN base inputs for reduced loading (20μA in High and Low states)
- Octal bidirectional bus interface
- Open collector outputs sink 64mA
- Non-inverting

#### DESCRIPTION

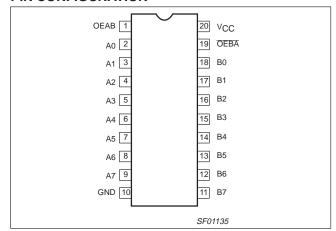
The 74F621 is an octal transceiver featuring non-inverting open collector bus-compatible outputs in both send and receive directions. The outputs are capable of sinking 64mA, providing very good capacitive drive characteristics.

This octal bus transceiver is designed for asynchronous two-way communication between data buses. The control function implementation allows for maximum flexibility in timing.

The device allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending upon the logic levels at the Enable inputs (OEBA and OEAB). The Enable inputs can be used to disable the device so that the buses are effectively isolated.

The dual-enable configuration gives the 74F621 the capability to store data by the simultaneous enabling of  $\overline{\text{OEBA}}$  and OEAB. Each output reinforces its input in this transceiver configuration. Thus, when both control inputs are enabled and all other data sources to the two sets of the bus lines are at high impedance, both sets of bus lines (16 in all) will remain in their last states.

### **PIN CONFIGURATION**



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F621	8.0ns	105mA

### **ORDERING INFORMATION**

DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V $\pm 10\%$ , $T_{amb}$ = 0°C to +70°C	PKG DWG#
20-pin plastic DIP	N74F621N	SOT146-1
20-pin plastic SOL	N74F621D	SOT163-1

### INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

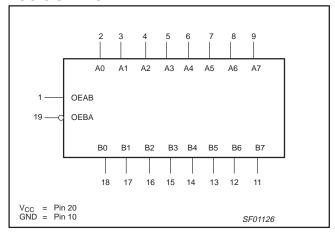
PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
A0 - A7, B0 - B7	Data inputs	1.0/0.033	20μΑ/20μΑ
OEBA, OEAB	Output Enable inputs	1.0/0.033	20μΑ/20μΑ
A0 - A7	Data outputs	OC/40	OC/24mA
B0 - B7	Data outputs	OC/106.7	OC/64mA

NOTE: One (1.0) FAST unit load is defined as: 20μA in the High state and 0.6mA in the Low state. OC = Open Collector.

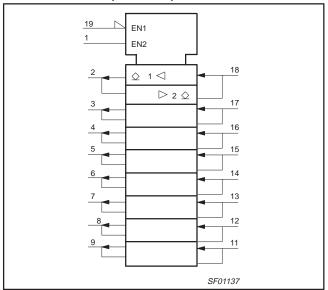
### Octal bus transceiver, non-inverting (open collector)

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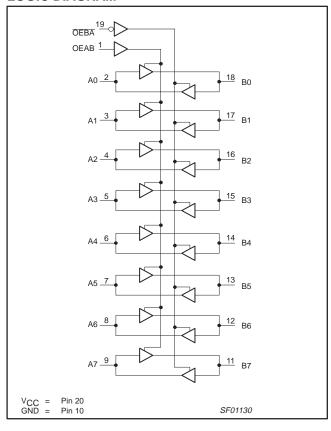
### **LOGIC SYMBOL**



### LOGIC SYMBOL (IEEE/IEC)



### **LOGIC DIAGRAM**



### **FUNCTION TABLE**

INPU	ITS	OPERATING MODES
OEBA	OEAB	OFERATING MODES
L	L	B data to A bus
Н	Н	A data to B bus
Н	L	OFF
	ш	B data to A bus
_	П	A data to B bus

H = High voltage level

L = Low voltage level

X = Don't care

OFF= High if pull-up resistor is connected to open collector output

# Octal bus transceiver, non-inverting (open collector)

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### **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V <sub>CC</sub>	Supply voltage		-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage		-0.5 to +7.0	V
I <sub>IN</sub>	Input current	−30 to +5	mA	
V <sub>OUT</sub>	Voltage applied to output in High output state	-0.5 to +5.5	V	
	Current applied to output in Lour output atota	A0-A7	48	mA
IOUT	Current applied to output in Low output state	128	mA	
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C	
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C	

### **RECOMMENDED OPERATING CONDITIONS**

OVMDOL	54544	AFTED.		LIMITS		UNIT
SYMBOL	PARAM	METER	MIN	NOM	MAX	UNII
V <sub>CC</sub>	Supply voltage		4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage		2.0			V
V <sub>IL</sub>	Low-level input voltage				0.8	V
I <sub>IK</sub>	Input clamp current				-18	mA
V <sub>OH</sub>	High-level output current				4.5	V
	I am laval autant armant	A0–A7			24	mA
loL	Low-level output current	B0-B7			64	mA
T <sub>amb</sub>	Operating free-air temperature range	9	0		70	°C

### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

							LIMITS				
SYMBOL	PARAME	TER	TE.	TEST CONDITIONS <sup>NO TAG</sup>				MAX	UNIT		
I <sub>OH</sub>	High-level output cu	rrent	V <sub>CC</sub> = MIN,	V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX, V <sub>IH</sub> =MIN, V <sub>OH</sub> = MAX				250	μΑ		
	40.47			. 04	±10%V <sub>CC</sub>		0.35	0.50	V		
V	Low-level output	A0–A7	$V_{CC} = MIN,$	I <sub>OL</sub> = 24mA	±5%V <sub>CC</sub>		0.35	0.50	V		
V <sub>OL</sub>	voltage	DO D7	$V_{IL} = MAX,$ $V_{IH} = MIN,$	I <sub>OL</sub> = 48mA	±10%V <sub>CC</sub>		0.38	0.55	V		
		B0-B7		I <sub>OL</sub> = 64mA	±5%V <sub>CC</sub>		0.42	0.55	V		
V <sub>IK</sub>	Input clamp voltage	-	$V_{CC} = MIN, I_1$	$V_{CC} = MIN, I_I = I_{IK}$				-1.2	V		
	Input current at	OEBA, OEAB	V <sub>CC</sub> = MAX, V	' <sub>I</sub> = 7.0V				100	μΑ		
11	maximum input voltage	others	V <sub>CC</sub> = 0.0V, V	<sub>I</sub> = 5.5V				1	mA		
I <sub>IH</sub>	High-level input curr	ent	V <sub>CC</sub> = MAX, V	′ <sub>I</sub> = 2.7V				20	μΑ		
I <sub>IL</sub>	Low-level input curr	ent	$V_{CC} = MAX, V_I = 0.5V$			$V_{CC} = MAX, V_I = 0.5V$				-20	μΑ
	Cumply gurrant	Іссн	OEBA = OEAB = A0-A7 = 4.5V		–A7 = 4.5V		105	140	mA		
I <sub>CC</sub>	Supply current (total)	I <sub>CCL</sub>	$V_{CC} = MAX$	OEBA = OEAB = 4.5 A0–A7 = GND		105	140	mA			

#### NOTES:

<sup>1.</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

<sup>2.</sup> All typical values are at  $V_{CC}$  = 5V,  $T_{amb}$  = 25°C.

# Octal bus transceiver, non-inverting (open collector)

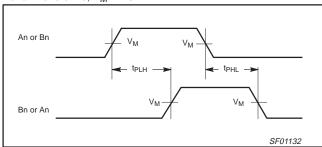
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### **AC ELECTRICAL CHARACTERISTICS**

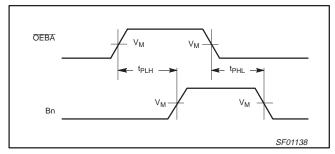
				LIMITS							
SYMBOL	PARAMETER	TEST CONDITION	T <sub>a</sub> C <sub>L</sub> = 5	/ <sub>CC</sub> = +5\ <sub>mb</sub> = +25 0pF, R <sub>L</sub> =	/ °C = 500Ω	V <sub>CC</sub> = +5 T <sub>amb</sub> = 0°C C <sub>L</sub> = 50pF,	UNIT				
			MIN	TYP	MAX	MIN	MAX				
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Bn	Waveform 1	6.0 4.0	9.5 6.0	12.0 8.0	5.5 3.5	13.0 8.5	ns			
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay Bn to An	Waveform 1	6.0 3.5	9.0 5.5	12.0 7.5	5.5 3.0	12.5 8.0	ns			
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay OEBA to An	Waveform 2	6.0 3.5	10.0 6.5	13.5 10.5	5.5 3.0	14.0 11.0	ns			
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay OEAB to Bn	Waveform 3	7.0 3.5	12.0 6.5	15.0 9.5	6.0 3.0	17.0 10.0	ns			

### **AC WAVEFORMS**

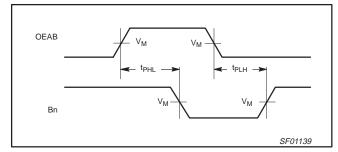
For all waveforms,  $V_M = 1.5V$ .



Waveform 1. For Non-Inverting Outputs



Waveform 2. Propagation Delay, OEBA to An



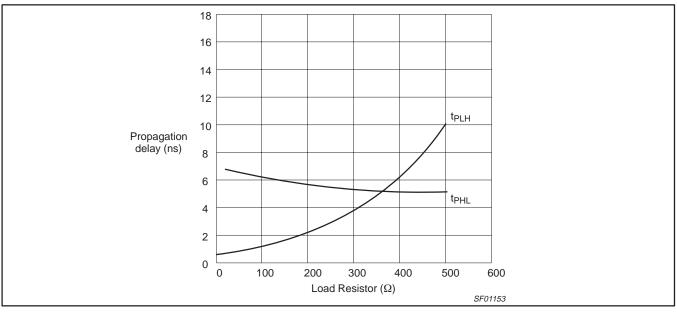
Waveform 3. Propagation Delay, OEAB to Bn

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### Octal bus transceiver, non-inverting (open collector)

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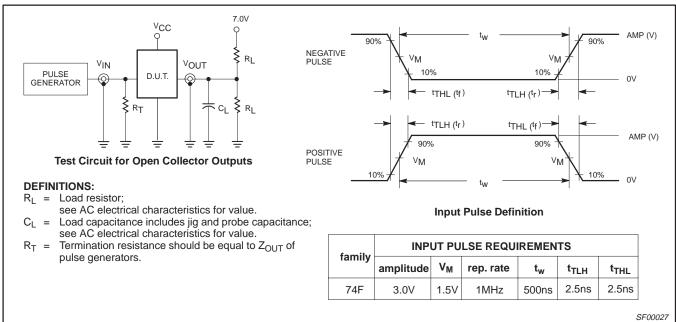
### TYPICAL PROPAGATION DELAYS VERSUS LOAD FOR OPEN COLLECTOR OUTPUTS



#### NOTE:

When using open-collector parts, the value of the pull-up resistor greatly affects the value of the  $t_{PLH}$ . For example, changing the pull-up resistor value from  $500\Omega$  to  $100\Omega$  will improve the  $t_{PLH}$  up to 50% with only slight increase in the  $t_{PHL}$ . However, if the pull-up resistor is changed, the user must take certain that the total  $I_{OL}$  current through the resistor and the total  $I_{IL}$ 's of the receivers do not exceed the  $I_{OL}$  maximum specification.

### **TEST CIRCUIT AND WAVEFORMS**

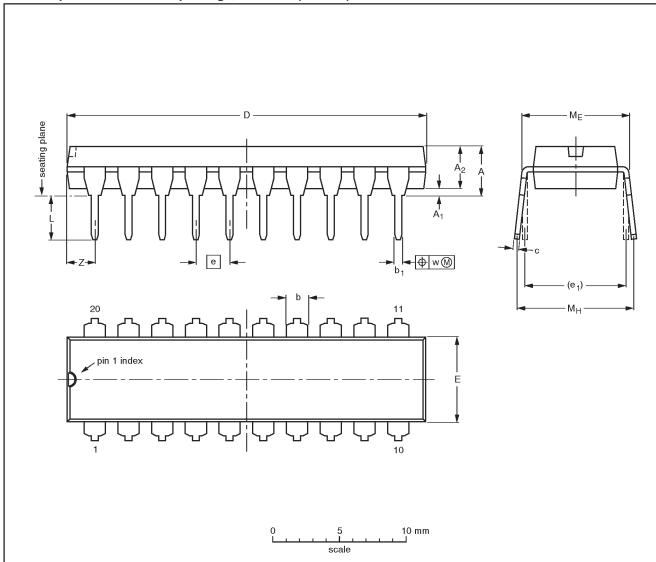


# Octal bus transceiver, non-inverting (open collector)

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### DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT146-1			SC603			<del>92-11-17</del> 95-05-24

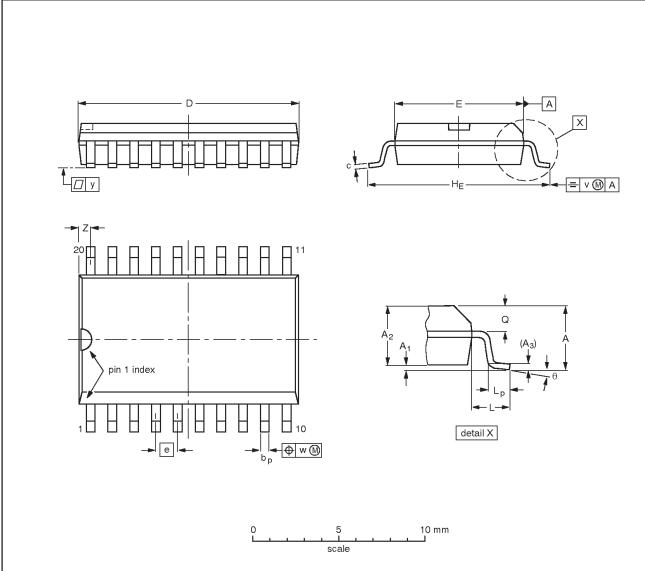
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# Octal bus transceiver, non-inverting (open collector)

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### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bр	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	z <sup>(1)</sup>	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016		0.01	0.01	0.004	0.035 0.016	O°

### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013AC				<del>-95-01-24</del> 97-05-22

Octal bus transceiver, non-inverting (open collector)

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**NOTES** 

### Octal bus transceiver, non-inverting (open collector)

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DEFINITIONS		
Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
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